

AP4412GM

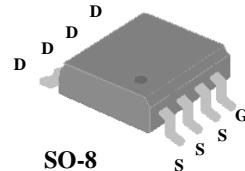
Pb Free Plating Product



**Advanced Power
Electronics Corp.**

*N-CHANNEL ENHANCEMENT MODE
POWER MOSFET*

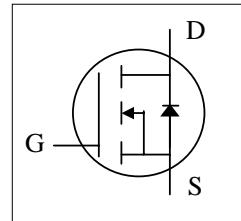
- ▼ Low Gate Charge
- ▼ Simple Drive Requirement
- ▼ Fast Switching
- ▼ RoHS Compliant



BV_{DSS}	25V
$R_{DS(ON)}$	33mΩ
I_D	7A

Description

The Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, ultra low on-resistance and cost-effectiveness.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	25	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_A = 25^\circ C$	Continuous Drain Current ³	7	A
$I_D @ T_A = 70^\circ C$	Continuous Drain Current ³	5.8	A
I_{DM}	Pulsed Drain Current ¹	30	A
$P_D @ T_A = 25^\circ C$	Total Power Dissipation	2.5	W
	Linear Derating Factor	0.02	W/°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Unit
R_{thj-a}	Thermal Resistance Junction-ambient ³	Max. 50	°C/W



Electrical Characteristics @ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=250\mu\text{A}$	25	-	-	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_j$	Breakdown Voltage Temperature Coefficient	Reference to 25°C , $I_{\text{D}}=1\text{mA}$	-	0.03	-	$\text{V}/^\circ\text{C}$
$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance ²	$V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=7\text{A}$	-	-	33	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$, $I_{\text{D}}=3.5\text{A}$	-	-	60	$\text{m}\Omega$
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=250\mu\text{A}$	1	-	3	V
g_{fs}	Forward Transconductance	$V_{\text{DS}}=10\text{V}$, $I_{\text{D}}=7\text{A}$	-	12	-	S
I_{DSS}	Drain-Source Leakage Current ($T_j=25^\circ\text{C}$)	$V_{\text{DS}}=25\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	1	uA
	Drain-Source Leakage Current ($T_j=70^\circ\text{C}$)	$V_{\text{DS}}=20\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	25	uA
I_{GSS}	Gate-Source Leakage	$V_{\text{GS}}=\pm 20\text{V}$	-	-	± 100	nA
Q_g	Total Gate Charge ²	$I_{\text{D}}=7\text{A}$	-	7	-	nC
Q_{gs}	Gate-Source Charge	$V_{\text{DS}}=16\text{V}$	-	1.5	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{\text{GS}}=5\text{V}$	-	5	-	nC
$t_{\text{d}(\text{on})}$	Turn-on Delay Time ²	$V_{\text{DS}}=16\text{V}$	-	7	-	ns
t_r	Rise Time	$I_{\text{D}}=7\text{A}$	-	22	-	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time	$R_G=3.3\Omega$, $V_{\text{GS}}=10\text{V}$	-	14.5	-	ns
t_f	Fall Time	$R_D=2.3\Omega$	-	6	-	ns
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$	-	218	-	pF
C_{oss}	Output Capacitance	$V_{\text{DS}}=25\text{V}$	-	155	-	pF
C_{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	63	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
I_s	Continuous Source Current (Body Diode)	$V_D=V_G=0\text{V}$, $V_S=1.2\text{V}$	-	-	2.08	A
V_{SD}	Forward On Voltage ²	$T_j=25^\circ\text{C}$, $I_s=2.3\text{A}$, $V_{\text{GS}}=0\text{V}$	-	-	1.2	V

Notes:

1. Pulse width limited by Max. junction temperature.
2. Pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
3. Surface mounted on 1 in² copper pad of FR4 board ; $125^\circ\text{C}/\text{W}$ when mounted on Min. copper pad.

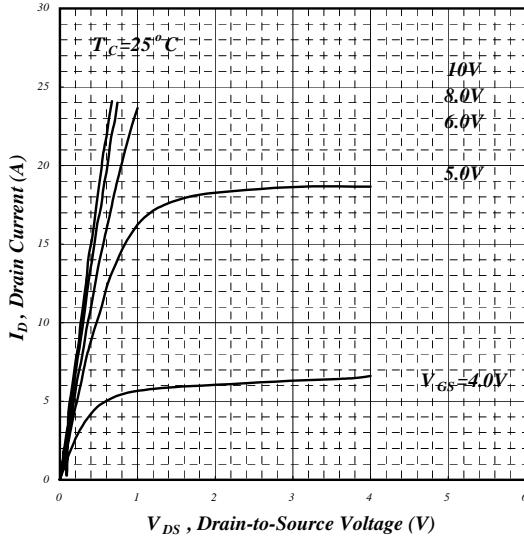


Fig 1. Typical Output Characteristics

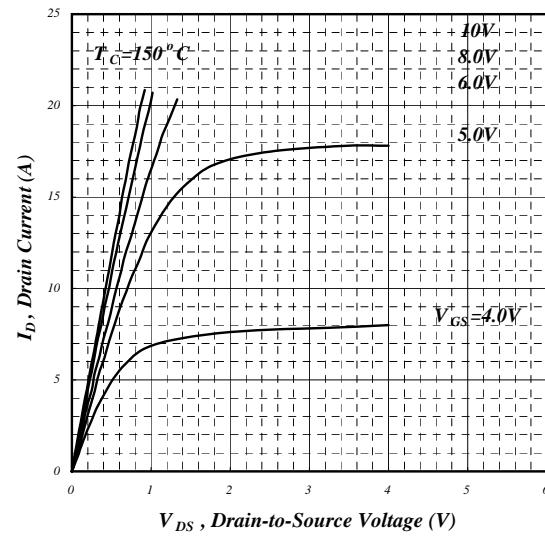


Fig 2. Typical Output Characteristics

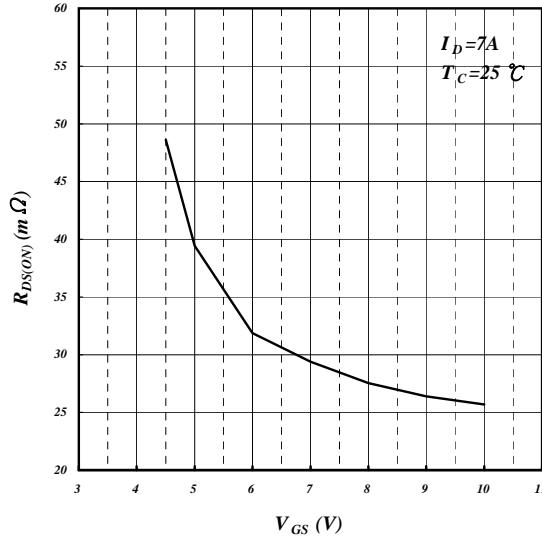


Fig 3. On-Resistance v.s. Gate Voltage

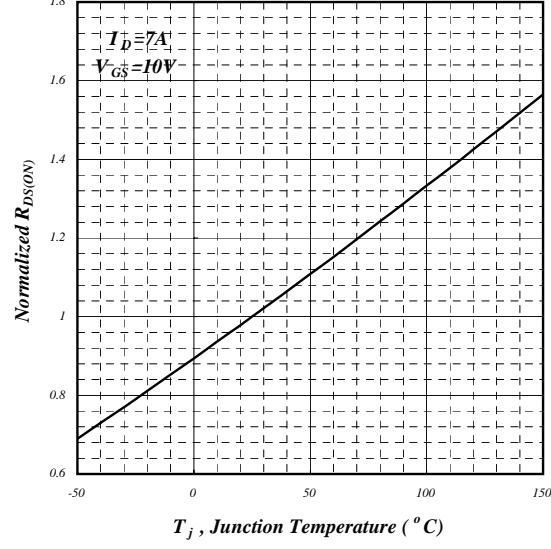
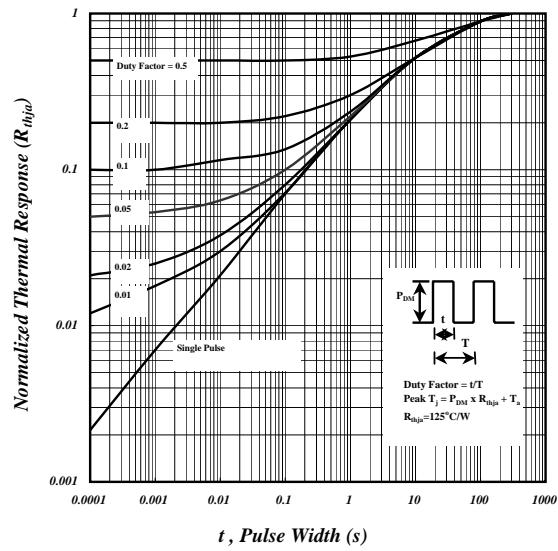
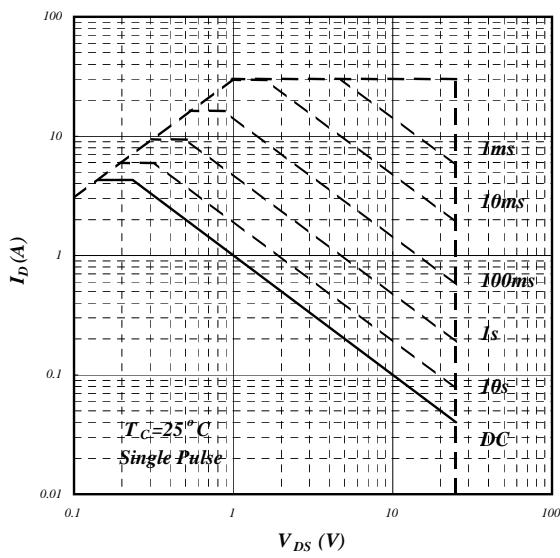
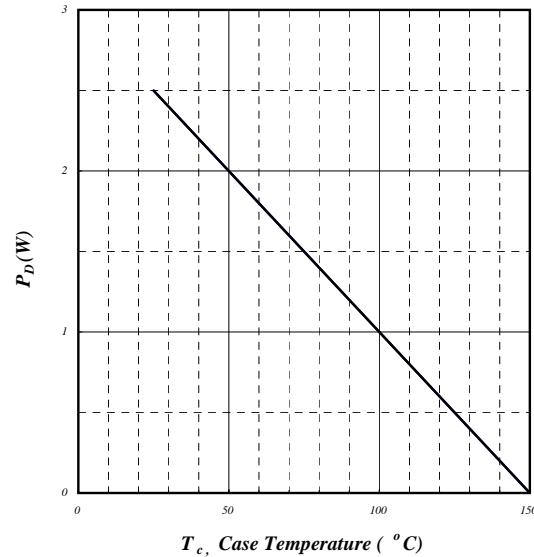
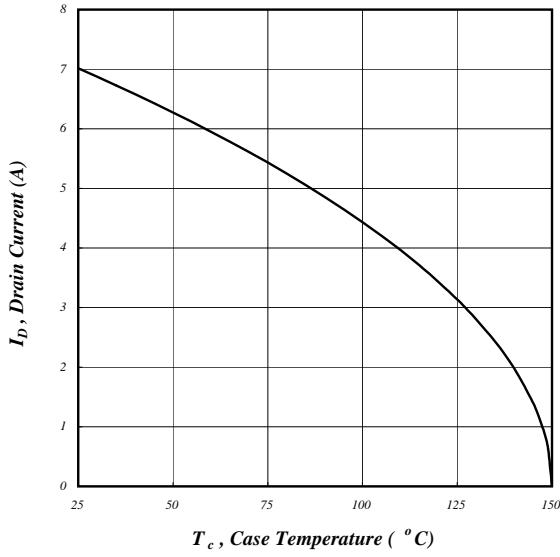
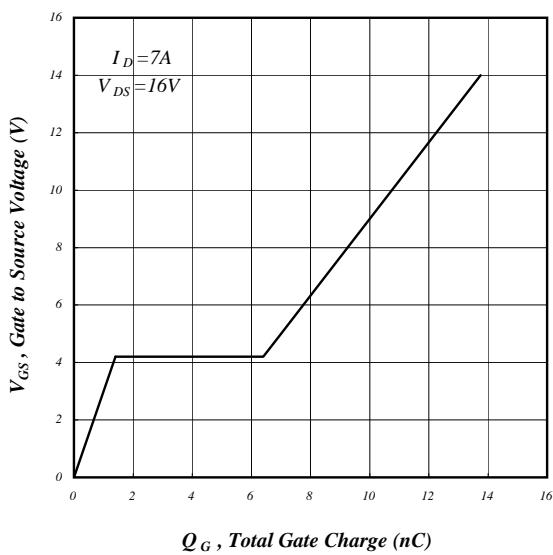
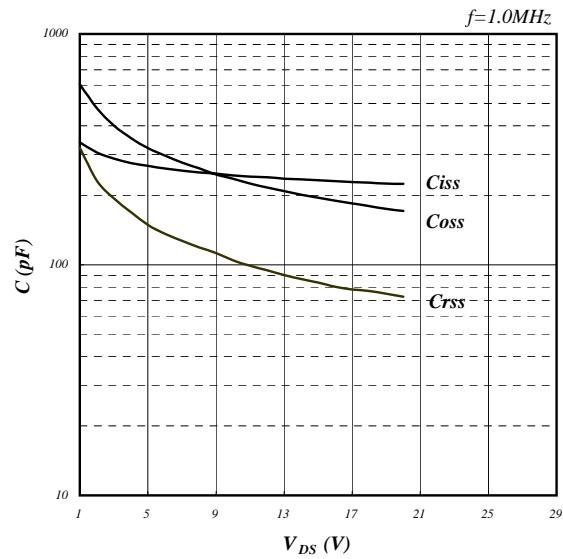
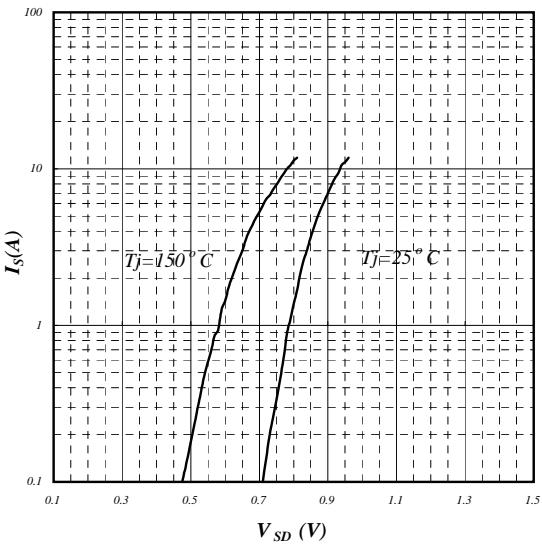
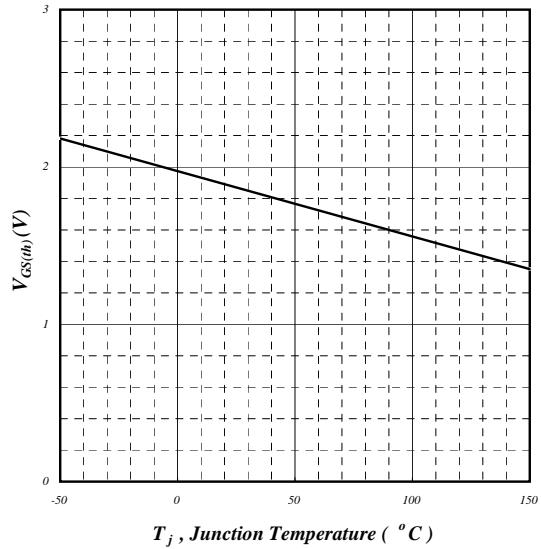


Fig 4. Normalized On-Resistance v.s. Junction Temperature




Fig 9. Gate Charge Characteristics

Fig 10. Typical Capacitance Characteristics

Fig 11. Forward Characteristic of Reverse Diode

Fig 12. Gate Threshold Voltage v.s. Junction Temperature



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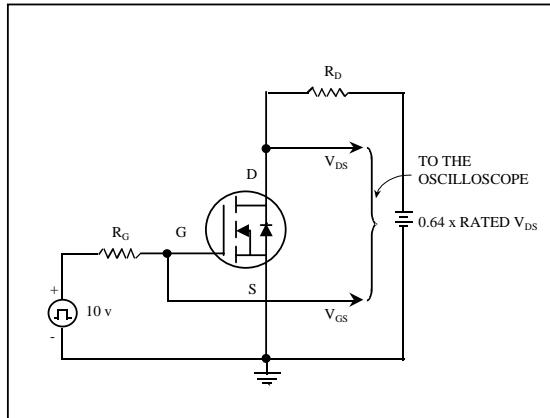


Fig 13. Switching Time Circuit

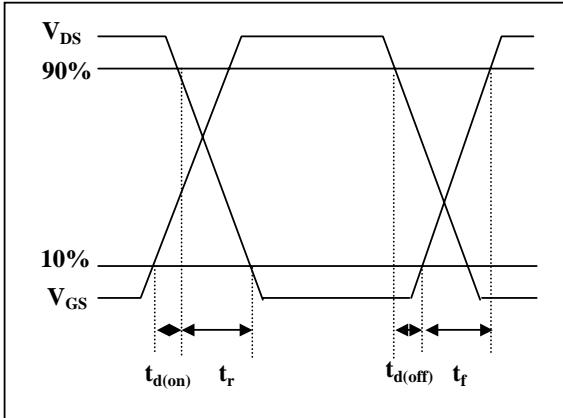


Fig 14. Switching Time Waveform

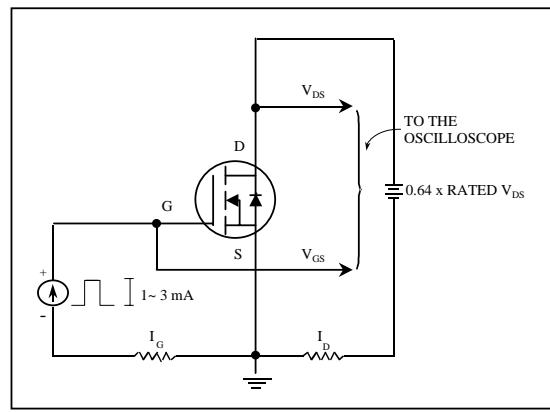


Fig 15. Gate Charge Circuit

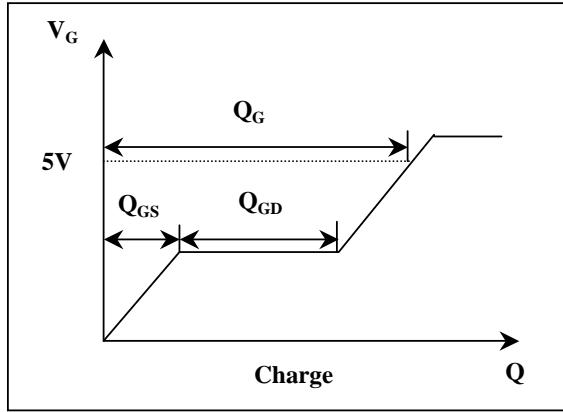


Fig 16. Gate Charge Waveform